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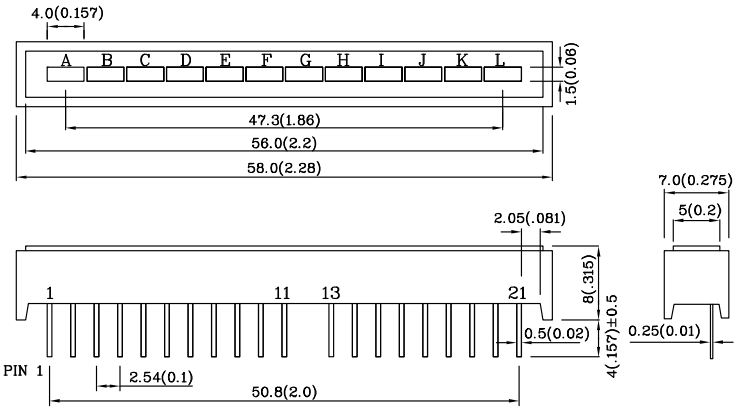
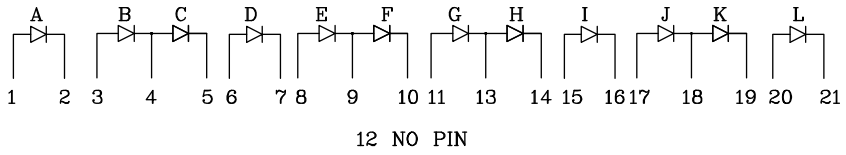
Part Number: **HUGX12DWB**

12 SEGMENT BAR GRAPH ARRAY

Features

- SUITABLE FOR LEVEL INDICATORS.
- LOW CURRENT OPERATION.
- WIDE VIEWING ANGLE.
- MECHANICALLY RUGGED.
- DIFFERENT COLORS IN ONE UNIT AVAILABLE.
- BLACK FACE, WHITE SEGMENT.
- RoHS COMPLIANT.





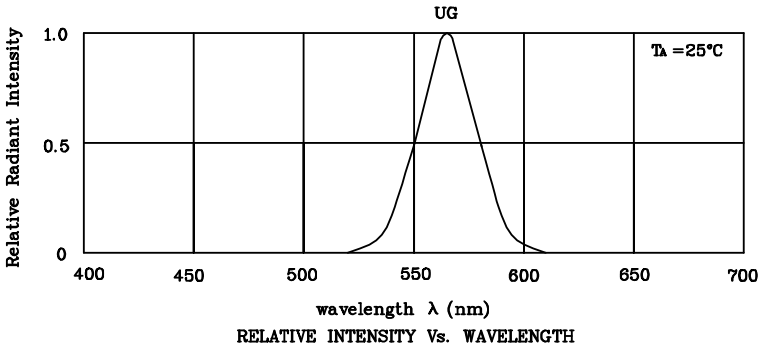
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25(0.01") unless otherwise note
3.Specifications are subject to change without notice.

Absolute Maximum Ratings (T_A=25°C)		**UG (GaP)**	**Unit**
Reverse Voltage	V_R	5	V
Forward Current	I_F	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	140	mA
Power Dissipation	P_T	62.5	mW
Operating Temperature	T_A	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3~5 Seconds		

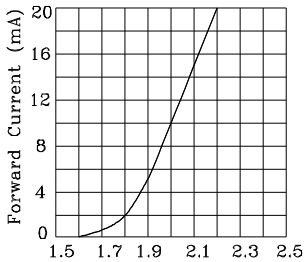
Operating Characteristics (T_A=25°C)		**UG (GaP)**	**Unit**
Forward Voltage (Typ.) (I_F=10mA)	V_F	2.0	V
Forward Voltage (Max.) (I_F=10mA)	V_F	2.5	V
Reverse Current (Max.) (V_R=5V)	I_R	10	uA
Wavelength of Peak Emission (Typ.) (I_F=10mA)	λ P	565	nm
Wavelength of Dominant Emission (Typ.) (I_F=10mA)	λ D	568	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I_F=10mA)	Δλ	30	nm
Capacitance (Typ.) (V_F=0V, f=1MHz)	C	15	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity (IF=10mA) ucd		Wavelength nm λ P	Description
			min.	typ.		
HUGX12DWB	Green	GaP	3000	15990	565	12 Segments Bargraph-Display

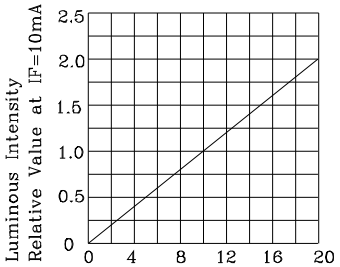


RELATIVE INTENSITY Vs. WAVELENGTH

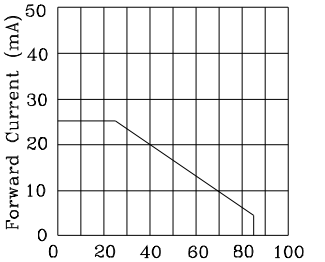
❖ **UG**



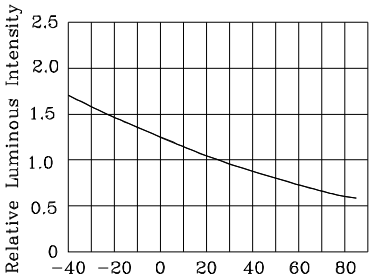
FORWARD CURRENT Vs.
FORWARD VOLTAGE



LUMINOUS INTENSITY Vs.
FORWARD CURRENT

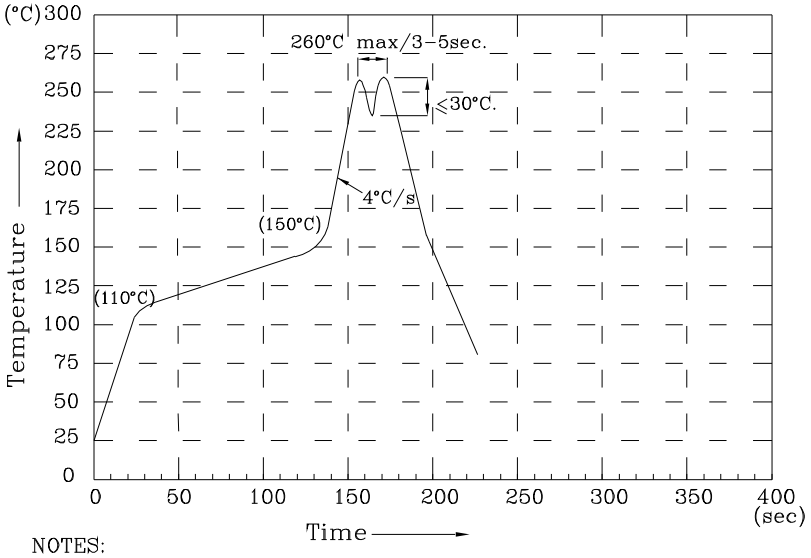


FORWARD CURRENT
DERATING CURVE



LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
2.Do not apply stress on epoxy resins when temperature is over 85 degree°C.
3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4.No more than once.

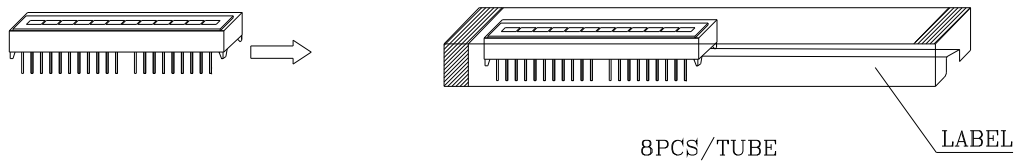
Remarks:

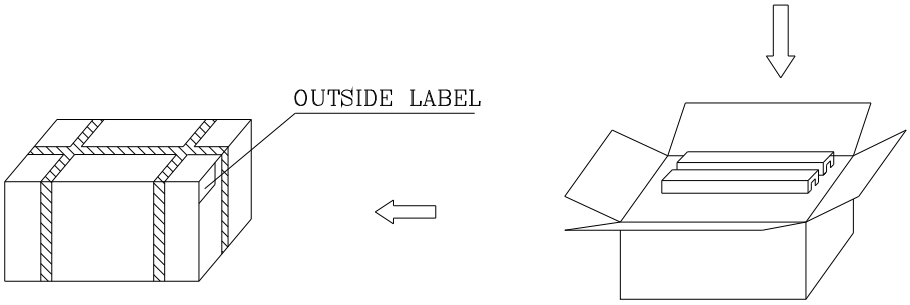
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

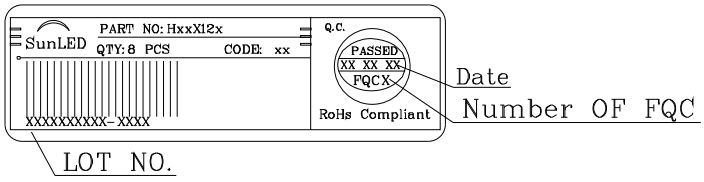
Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS HUGX12DWB





Inside LABEL Paste On The IC-tube



Outside LABEL Paste On The Box